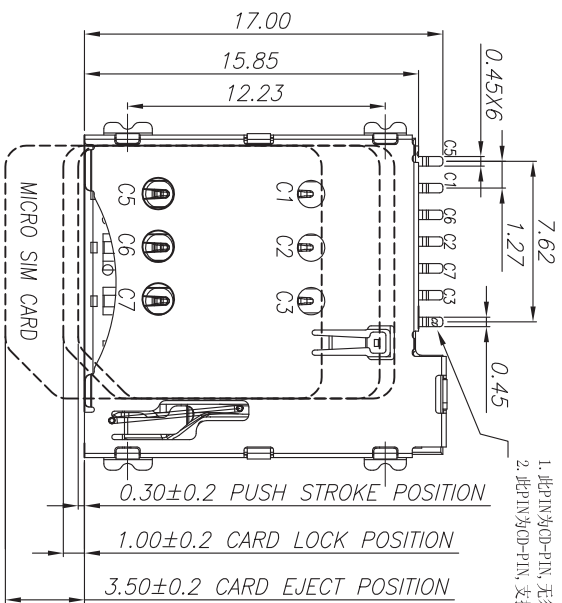
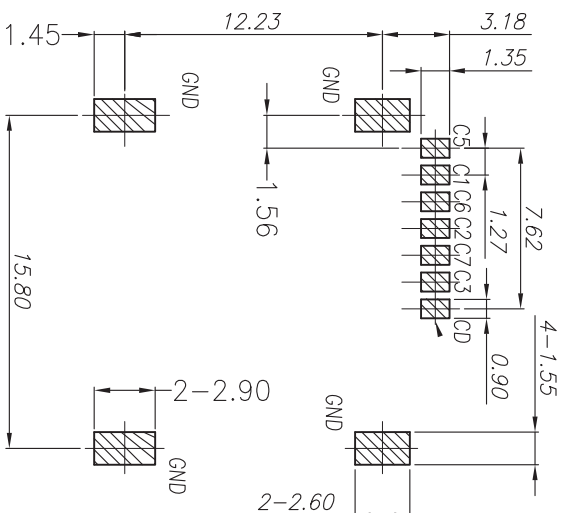
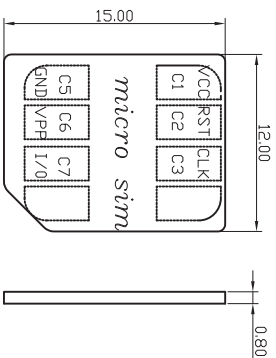
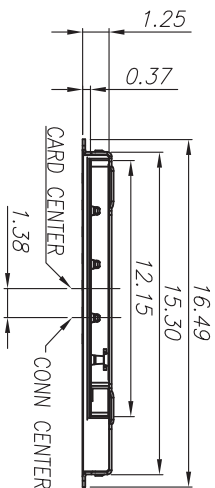
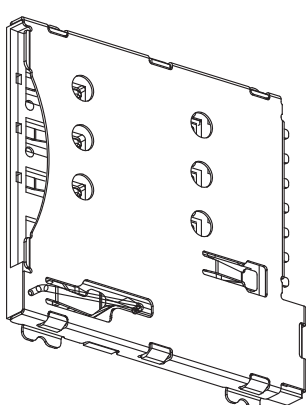
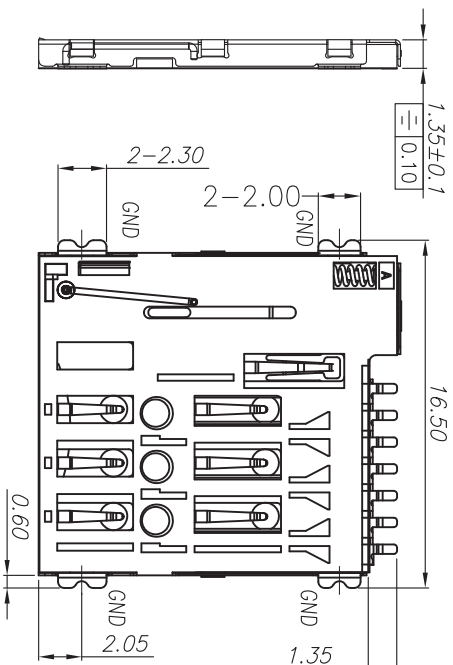




1. 此PIN为OD+PIN, 无须时, 此PIN无须设计PCB焊盘, 实物有此PIN脚
2. 此PIN为OD+PIN, 支持热插拔, 有须要可设计此功能。



SIM pin Assignment	PIN#	Name
C1	VCC	VCC
C2	RST	RST
C3	CLK	CLK
C5	GND	GND
C6	VPP	VPP
C7	I/O	I/O

NOTES:
MATERIAL:
Insulator: High Temperature Thermoplastic 94V-0.
Contact: Copper Alloy
Shell: STAINLESS

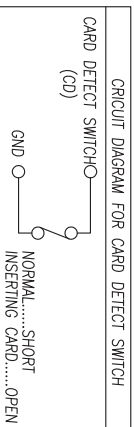
PLATING:

Contact: Plated 30μ" Ni Overall Contact 6/F
Shell: Plated 30μ" Ni Overall
Plated 6/F Selective Contact Area

Electrical:

Current Rating :0.5mA AC/DC max.
Voltage Rating :250V AC/DC
Ambient Temperature Range :-20° C~+85° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩmax.
Insulation Resistance:1000MΩmin./500VDC
Mating Cycles:5,000 Insertions
Temperature: 260° C ±5°

MICRO SIM CARD



5001 - SM2135 B - 07 R 1.00
Micro卡座
H=1.35
自弹式
ALTERNATE
PACKING:R:卷
PIN

TOLERANCES UNLESS	
X. ± 0.50	X. ^o ± 3'
.X ± 0.38	.X. ^o ± 2'
.XX ± 0.25	.XX. ^o ± 1'
.XXX ± 0.10	.XXX. ^o ± 0.5'

深圳市文章济美科技有限公司		DATE 2014/3/27	
TITLE: 产品名称	MICRO SIM PUSH 6+1P	UNIT	DESIGNED
PART NUMBER: 零件编号	5001-SM2135B-07R1-00	SCALE	CHECKED
DRAWING NUMBER: 图纸编号		SHEET	APPROVED
		页码	1/1
		比例	1:1
		核准	审核
		审批	审批